

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	BSZ024N04LS6	**Issued**	08. April 2022
MA#	MA005709819		
Package	PG-TSDSON-8-26	**Weight***	36.69 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	0.610	1.66	1.66	16631	16631
leadframe	inorganic material	phosphorus	7723-14-0	0.002	0.01		67	
	non noble metal	zinc	7440-66-6	0.010	0.03		268	
	non noble metal	iron	7439-89-6	0.197	0.54		5363	
	non noble metal	copper	7440-50-8	7.988	21.78	22.36	217751	223449
wire	noble metal	gold	7440-57-5	0.028	0.08	0.08	751	751
encapsulation	organic material	carbon black	1333-86-4	0.037	0.10		1006	
	plastics	epoxy resin	-	1.901	5.18		51810	
	inorganic material	silicondioxide	60676-86-0	16.516	45.00	50.28	450191	503007
leadfinish	non noble metal	tin	7440-31-5	0.395	1.08	1.08	10774	10774
plating	noble metal	silver	7440-22-4	0.020	0.06	0.06	554	554
solder	non noble metal	tin	7440-31-5	0.017	0.05		461	
	noble metal	silver	7440-22-4	0.021	0.06		577	
	non noble metal	lead	7439-92-1	0.808	2.20	2.31	22026	23064
heat sink clip	inorganic material	phosphorus	7723-14-0	0.001			35	
	non noble metal	zinc	7440-66-6	0.005	0.01		138	
	non noble metal	iron	7439-89-6	0.101	0.28		2761	
	non noble metal	copper	7440-50-8	4.112	11.21	11.50	112098	115032
heatspreader	inorganic material	phosphorus	7723-14-0	0.001			32	
	non noble metal	zinc	7440-66-6	0.005	0.01		128	
	non noble metal	iron	7439-89-6	0.094	0.26		2562	
	non noble metal	copper	7440-50-8	3.816	10.40	10.67	104016	106738
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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